

## 4N65K-TA

**Power MOSFET**

4.0A, 650V N-CHANNEL  
POWER MOSFET

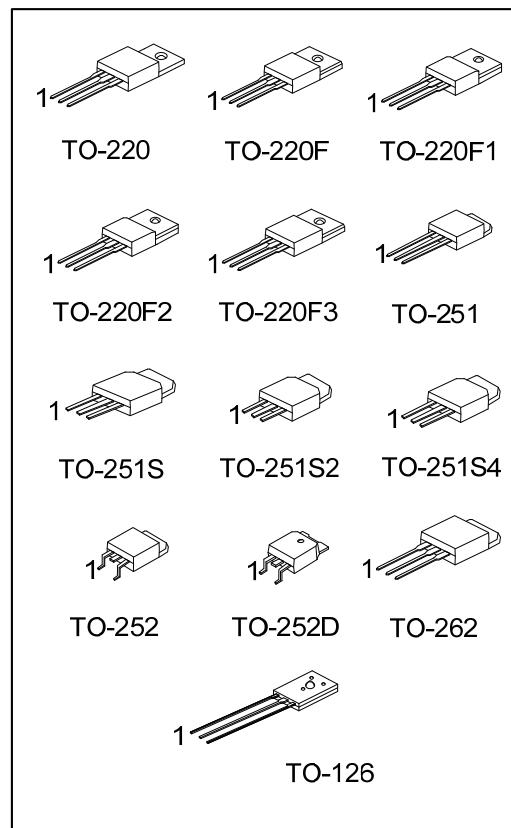
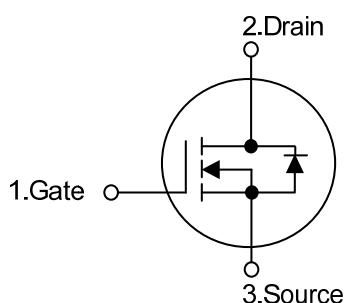
### ■ DESCRIPTION

The UTC 4N65K-TA is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristic. This power MOSFET is usually used in high speed switching applications including power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

### ■ FEATURES

- \*  $R_{DS(ON)} < 2.8\Omega$  @  $V_{GS} = 10$  V,  $I_D = 2.2$  A
- \* Fast Switching Capability
- \* Avalanche Energy Specified
- \* Improved dv/dt Capability, High Ruggedness

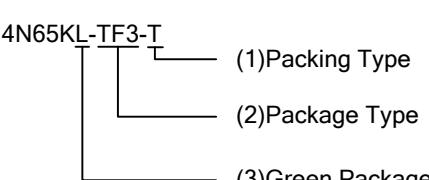
### ■ SYMBOL



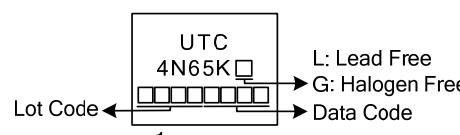
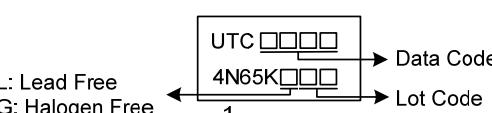
### ■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
4N65KL-TA3-T	4N65KG-TA3-T	TO-220	G	D	S	Tube
4N65KL-TF3-T	4N65KG-TF3-T	TO-220F	G	D	S	Tube
4N65KL-TF1-T	4N65KG-TF1-T	TO-220F1	G	D	S	Tube
4N65KL-TF2-T	4N65KG-TF2-T	TO-220F2	G	D	S	Tube
4N65KL-TF3T-T	4N65KG-TF3T-T	TO-220F3	G	D	S	Tube
4N65KL-TM3-T	4N65KG-TM3-T	TO-251	G	D	S	Tube
4N65KL-TMS-T	4N65KG-TMS-T	TO-251S	G	D	S	Tube
4N65KL-TMS2-T	4N65KG-TMS2-T	TO-251S2	G	D	S	Tube
4N65KL-TMS4-T	4N65KG-TMS4-T	TO-251S4	G	D	S	Tube
4N65KL-TN3-R	4N65KG-TN3-R	TO-252	G	D	S	Tape Reel
4N65KL-TND-R	4N65KG-TND-R	TO-252D	G	D	S	Tape Reel
4N65KL-T2Q-T	4N65KG-T2Q-T	TO-262	G	D	S	Tube
4N65KL-T60-K	4N65KG-T60-K	TO-126	G	D	S	Bulk

Note: Pin Assignment: G: Gate D: Drain S: Source

 4N65KL-TF3-T (1)Packing Type (2)Package Type (3)Green Package	(1) T: Tube, R: Tape Reel, K: Bulk (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TM1: TO-220F2, TF3T: TO-220F3, TM3: TO-251, TMS: TO-251S, TMS2: TO-251S2, TMS4: TO-251S4, TN3: TO-252, TMD: TO-252D, T2Q: TO-262, T60: TO-126 (3) L: Lead Free, G: Halogen Free and Lead Free
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### ■ MARKING

PACKAGE		MARKING
TO-220	TO-251S	 Lot Code ← → Data Code 1
TO-220F TO-220F1 TO-220F2 TO-220F3 TO-251	TO-251S2 TO-251S4 TO-252 TO-252D TO-262	 L: Lead Free ← → Data Code G: Halogen Free ← → Lot Code 1

■ ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	650	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	Continuous	$I_D$	4.0	A
	Pulsed (Note2)	$I_{DM}$	16	A
Avalanche Energy	Single Pulsed (Note3)	$E_{AS}$	150	mJ
Peak Diode Recovery dv/dt (Note4)		dv/dt	3.5	V/ns
Power Dissipation	TO-220/TO-262	$P_D$	106	W
	TO-220F		34	W
	TO-220F1/TO-220F2		36	W
	TO-220F3			
	TO-251/TO-251S		50	W
	TO-251S2/ TO-251S4			
	TO-252/TO-252D		45	W
TO-126				
Junction Temperature	$T_J$		+150	$^\circ\text{C}$
Operating Temperature	$T_{OPR}$		-55 ~ +150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$		-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3.  $L=18.75\text{mH}$ ,  $I_{AS}=4\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD}\leq 4.4\text{A}$ ,  $di/dt\leq 200\text{A}/\mu\text{s}$ ,  $V_{DD}\leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

## ■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F	$\theta_{JA}$	62.5	$^\circ\text{C/W}$
	TO-220F1/TO-220F2			
	TO-220F3/TO-262			
Junction to Case	TO-251/TO-251S	$\theta_{JC}$	110	$^\circ\text{C/W}$
	TO-251S2/ TO-251S4			
	TO-252/TO-252D			
	TO-126			
	TO-220		1.18	$^\circ\text{C/W}$
	TO-220F/TO-220F1			
	TO-220F3			
	TO-220F2			
	TO-251/TO-251S		2.5	$^\circ\text{C/W}$
	TO-251S2/ TO-251S4			
	TO-252/TO-252D			
	TO-262			
	TO-126			

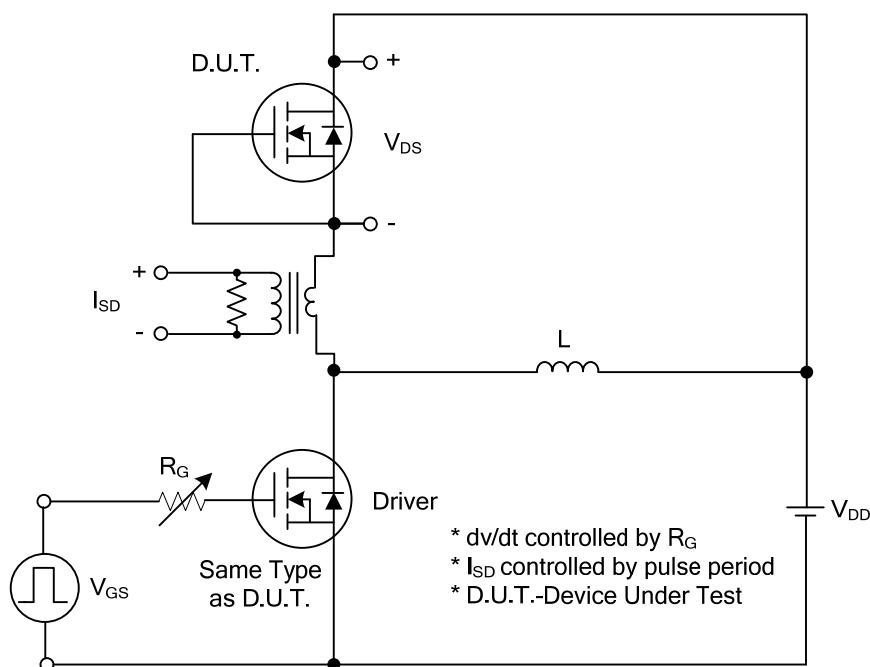
■ ELECTRICAL CHARACTERISTICS ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0 \text{ V}, I_{\text{D}} = 250\mu\text{A}$	650			V
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 650 \text{ V}, V_{\text{GS}} = 0 \text{ V}$		10		$\mu\text{A}$
Gate-Source Leakage Current	Forward	$V_{\text{GS}} = 30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$		100		nA
	Reverse	$V_{\text{GS}} = -30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$		-100		nA
Breakdown Voltage Temperature Coefficient	$\Delta\text{BV}_{\text{DSS}}/\Delta T_J$	$I_{\text{D}} = 250\mu\text{A}$ , Referenced to $25^\circ\text{C}$	0.6			$\text{V}/^\circ\text{C}$
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{\text{GS(TH)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250\mu\text{A}$	3.0		5.0	V
Static Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}} = 10 \text{ V}, I_{\text{D}} = 2.2\text{A}$			2.8	$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{\text{ISS}}$	$V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		320	520	pF
Output Capacitance	$C_{\text{OSS}}$			50	75	pF
Reverse Transfer Capacitance	$C_{\text{RSS}}$			5	10	pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge	$Q_G$	$V_{\text{DS}} = 50\text{V}, V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 1.3\text{A}, I_{\text{D}} = 100\mu\text{A}$ (Note 1, 2)		14	18	nC
Gate-Source Charge	$Q_{\text{GS}}$			5		nC
Gate-Drain Charge	$Q_{\text{GD}}$			2.8		nC
Turn-On Delay Time	$t_{\text{D(ON)}}$			48	68	ns
Turn-On Rise Time	$t_R$			45	56	ns
Turn-Off Delay Time	$t_{\text{D(OFF)}}$	$V_{\text{DD}} = 30\text{V}, V_{\text{GS}} = 10\text{V}$ $I_{\text{D}} = 0.5\text{A}, R_{\text{G}} = 25\Omega$ (Note 1, 2)		74	90	ns
Turn-Off Fall Time	$t_F$			34	45	ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_S$				4.4	A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{\text{SM}}$				17.6	A
Drain-Source Diode Forward Voltage	$V_{\text{SD}}$	$I_S = 4.4\text{A}, V_{\text{GS}} = 0 \text{ V}$			1.4	V
Reverse Recovery Time	$t_{\text{rr}}$	$I_S = 4.4\text{A}, V_{\text{GS}} = 0 \text{ V}$		450		ns
Reverse Recovery Charge	$Q_{\text{RR}}$	$dI_F/dt = 100\text{A}/\mu\text{s}$ (Note 1)		2.3		$\mu\text{C}$

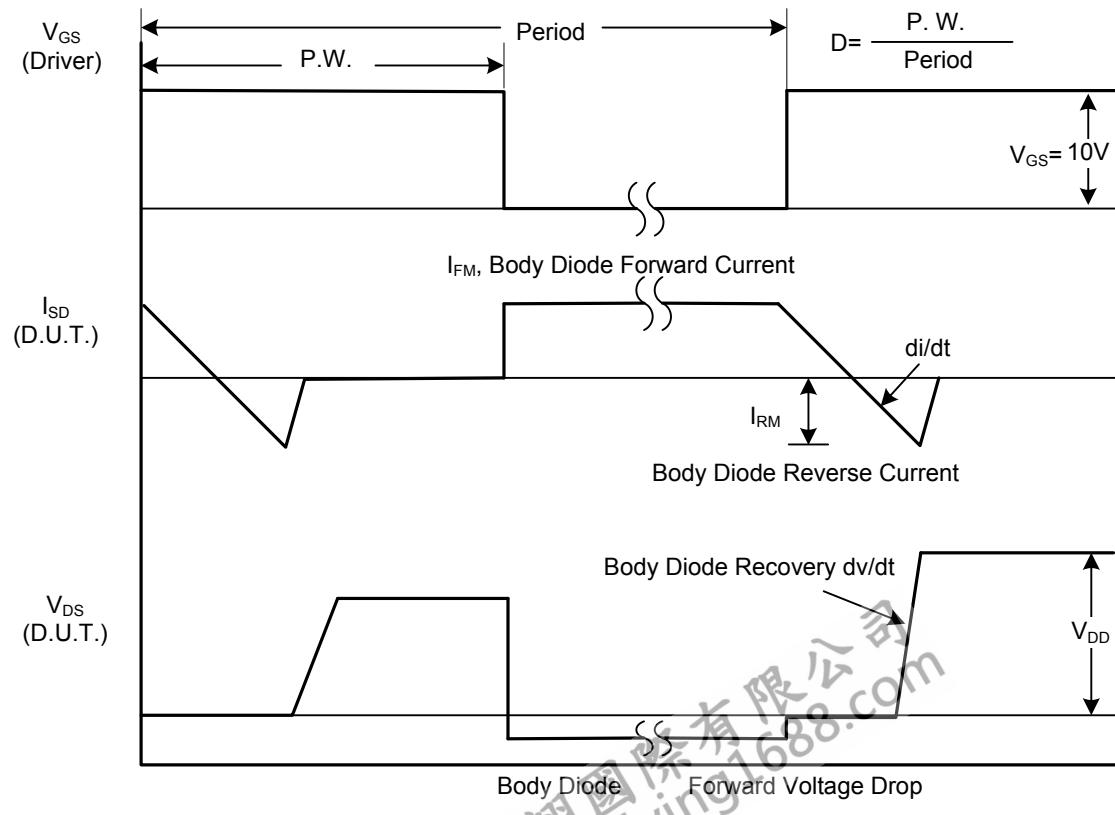
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating temperature.

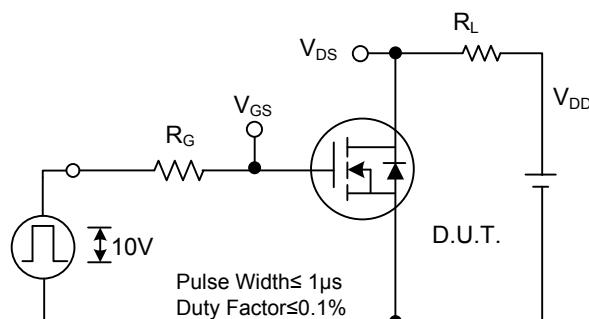
■ TEST CIRCUITS AND WAVEFORMS



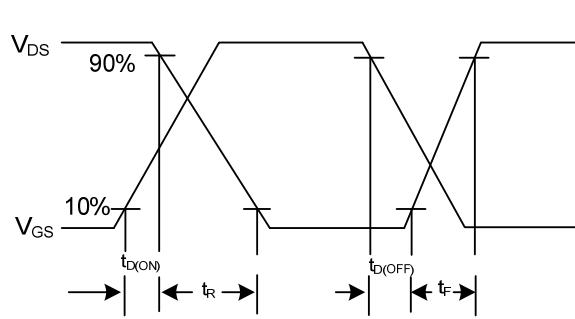
Peak Diode Recovery dv/dt Test Circuit



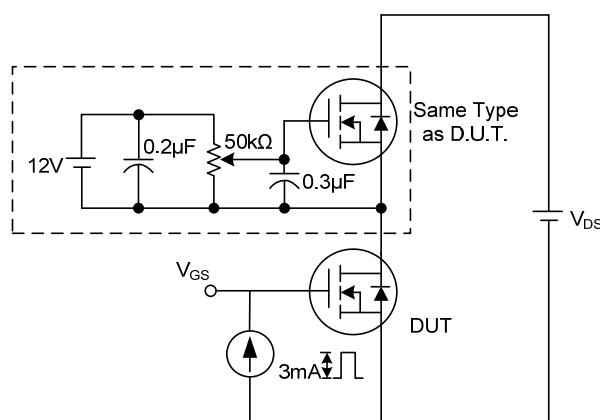
## ■ TEST CIRCUITS AND WAVEFORMS (Cont.)



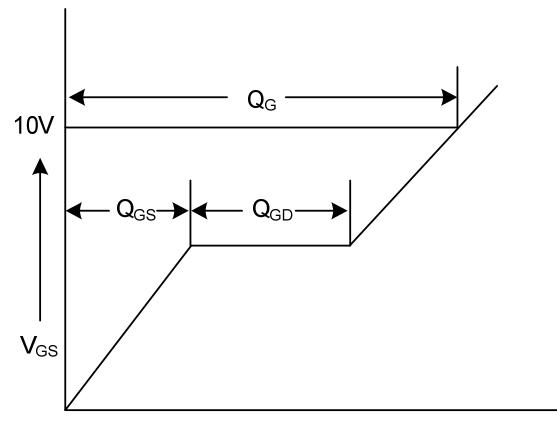
Switching Test Circuit



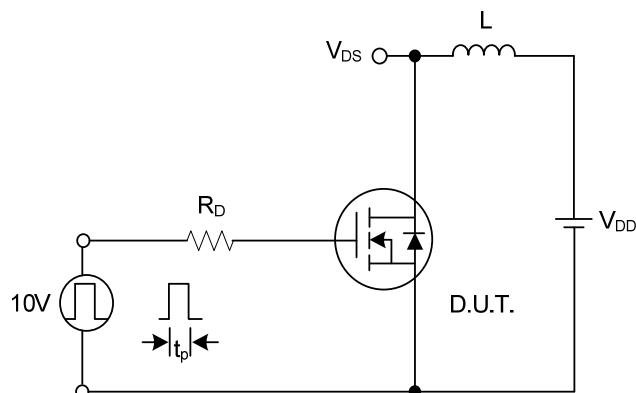
Switching Waveforms



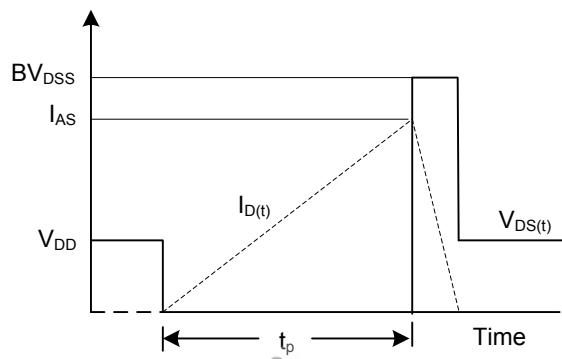
Gate Charge Test Circuit



Gate Charge Waveform

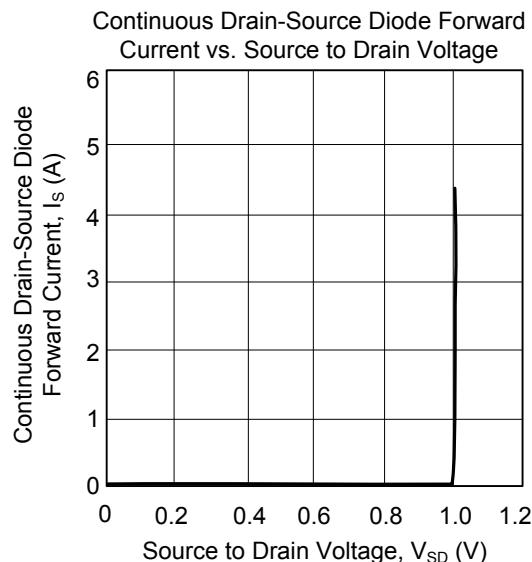
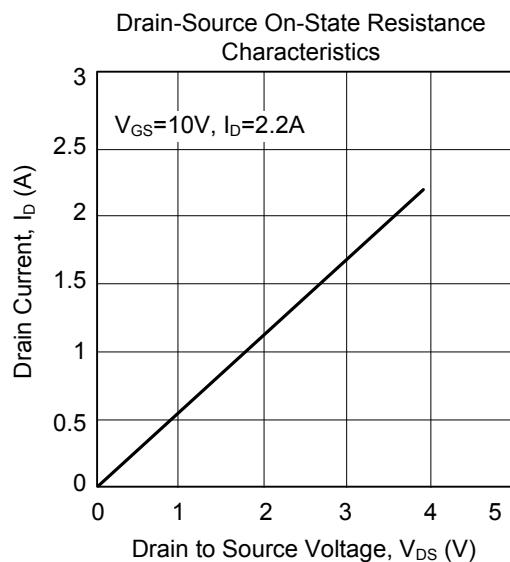
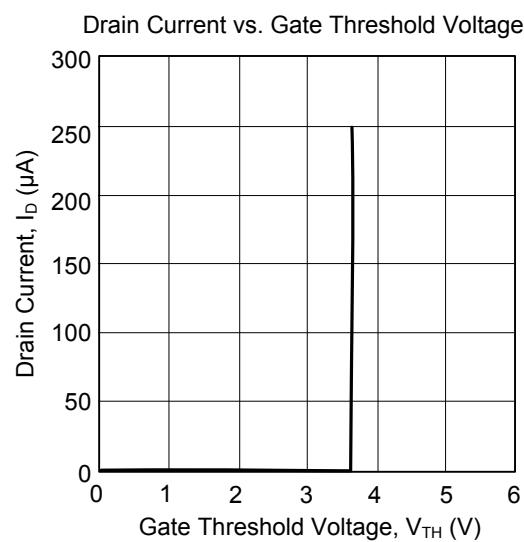
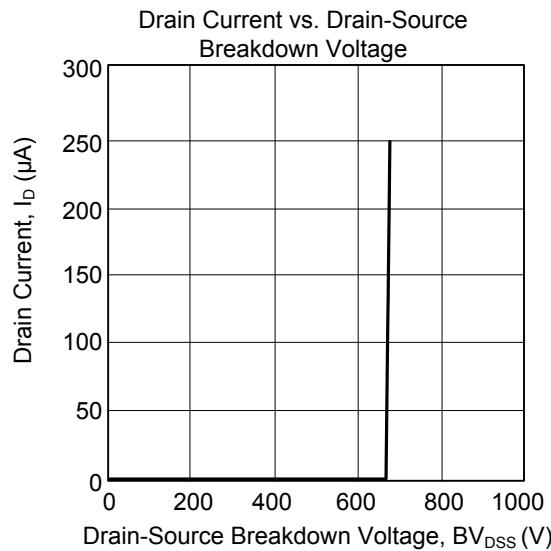


Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS



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